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Vishay Siliconix

# N-Channel 8 V (D-S) MOSFET



## Marking code: F2

| PRODUCT SUMMARY  |        |  |  |  |  |
|--|--------|--|--|--|--|
| V <sub>DS</sub> (V)  | 8      |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$ | 0.017  |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 2.5 \text{ V}$ | 0.020  |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 1.8 \text{ V}$ | 0.022  |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 1.5 \text{ V}$ | 0.030  |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 1.2 \text{ V}$ | 0.075  |  |  |  |  |
| Q <sub>g</sub> typ. (nC)                                   | 6      |  |  |  |  |
| I <sub>D</sub> (A) a, e                                    | 6      |  |  |  |  |
| Configuration  | Single |  |  |  |  |

#### **FEATURES**

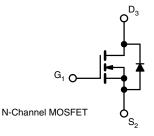
- TrenchFET® power MOSFET
- · Low on-resistance
- 100 % R<sub>q</sub> tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



HALOGEN **FREE** 

#### **APPLICATIONS**

- · Load switches for low voltage gate drive
- · Low voltage operating circuits
  - Gate drive 1.2 V to 5 V



| ORDERING INFORMATION            |                 |
|---------------------------------|-----------------|
| Package                         | SOT-23          |
| Lead (Pb)-free and halogen-free | Si2342DS-T1-GE3 |

| <b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted) |                        |                                   |                     |      |
|--|------------------------|-----------------------------------|---------------------|------|
| PARAMETER  |                        | SYMBOL                            | LIMIT               | UNIT |
| Drain-source voltage   |                        | $V_{DS}$                          | 8                   | V    |
| Gate-source voltage  |                        | $V_{GS}$                          | ± 5                 | V    |
| -  | T <sub>C</sub> = 25 °C |                                   | 6 <sup>e</sup>      |      |
| Continuous drain surrent /T 150 °C)  | T <sub>C</sub> = 70 °C | Ι. Γ                              | 6 <sup>e</sup>      |      |
| Continuous drain current (T <sub>J</sub> = 150 °C)                               | T <sub>A</sub> = 25 °C | I <sub>D</sub>                    | 6 b, c, e           |      |
|  | T <sub>A</sub> = 70 °C | †                                 | 5.8 <sup>b, c</sup> | Α    |
| Pulsed drain current (t = 300 μs)  |                        | I <sub>DM</sub>                   | 30                  |      |
| Canting and a summer during diagle assument                                      | T <sub>C</sub> = 25 °C |                                   | 2.1                 |      |
| Continuous source-drain diode current  | T <sub>A</sub> = 25 °C | l <sub>S</sub>                    | 1.1 <sup>b, c</sup> |      |
| Maximum power dissipation  | T <sub>C</sub> = 25 °C |                                   | 2.5                 |      |
|  | T <sub>C</sub> = 70 °C | ] , [                             | 1.6                 | 14/  |
|  | T <sub>A</sub> = 25 °C | P <sub>D</sub>                    | 1.3 <sup>b, c</sup> | w    |
|  | T <sub>A</sub> = 70 °C | Ī                                 | 0.8 b, c            |      |
| Operating junction and storage temperature range                                 |                        | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150         | °C   |
| Soldering recommendations (peak temperature)                                     |                        |                                   | 260                 |      |

| THERMAL RESISTANCE RATINGS       |              |                   |         |      |      |  |  |
|----------------------------------|--------------|-------------------|---------|------|------|--|--|
| PARAMETER                        | SYMBOL       | TYPICAL           | MAXIMUM | UNIT |      |  |  |
| Maximum junction-to-ambient b, d | t ≤ 5 s      | R <sub>thJA</sub> | 75      | 100  | °C/W |  |  |
| Maximum junction-to-foot (drain) | Steady state | $R_{thJF}$        | 40      | 50   | C/VV |  |  |

### Notes

- a. Based on T<sub>C</sub> = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
  d. Maximum under steady state conditions is 166 °C/W
- e. Package limited



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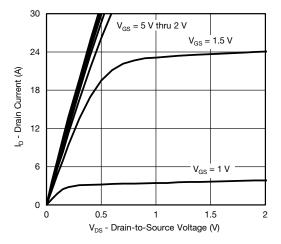
| PARAMETER                                   | SYMBOL                  | TEST CONDITIONS  | MIN. | TYP.  | MAX.  | UNIT  |  |
|---|-------------------------|--|------|-------|-------|-------|--|
| Static                                      |                         |  |      |       |       | •     |  |
| Drain-source breakdown voltage              | $V_{DS}$                | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$                          | 8    | -     | -     | V     |  |
| V <sub>DS</sub> temperature coefficient     | $\Delta V_{DS}/T_{J}$   | 1 050 A  | -    | 10    | -     | mV/°C |  |
| V <sub>GS(th)</sub> temperature coefficient | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = 250 μA  | -    | -2.5  | -     |       |  |
| Gate-source threshold voltage               | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$                                | 0.35 | -     | 0.8   | V     |  |
| Gate-source leakage                         | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$                       | -    | -     | ± 100 | nA    |  |
| Zara gata valtaga drain avrent              | ,                       | V <sub>DS</sub> = 8 V, V <sub>GS</sub> = 0 V                           | -    | -     | 1     |       |  |
| Zero gate voltage drain current             | I <sub>DSS</sub>        | V <sub>DS</sub> = 8 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C - |      | -     | 10    | μA    |  |
| On-state drain current <sup>a</sup>         | I <sub>D(on)</sub>      | $V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$                       | 20   | -     | -     | Α     |  |
|   |                         | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 7.2 A                        | -    | 0.014 | 0.017 | 1     |  |
|   |                         | $V_{GS} = 2.5 \text{ V}, I_D = 6.7 \text{ A}$                          | -    | 0.016 | 0.020 |       |  |
| Drain-source on-state resistance a          | R <sub>DS(on)</sub>     | V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 6.4 A                        | -    | 0.018 | 0.022 | Ω     |  |
|   |                         | V <sub>GS</sub> = 1.5 V, I <sub>D</sub> = 5.5 A                        | -    | 0.020 | 0.030 |       |  |
|   |                         | V <sub>GS</sub> = 1.2 V, I <sub>D</sub> = 1.3 A                        | -    | 0.025 | 0.075 | 1     |  |
| Forward transconductance <sup>a</sup>       | 9 <sub>fs</sub>         | V <sub>DS</sub> = 4 V, I <sub>D</sub> = 7.2 A                          | -    | 75    | -     | S     |  |
| Dynamic <sup>b</sup>                        | · · · · ·               |  |      |       |       |       |  |
| Input capacitance                           | C <sub>iss</sub>        |  | -    | 1070  | -     | pF    |  |
| Output capacitance                          | C <sub>oss</sub>        | $V_{DS} = 4 V$ , $V_{GS} = 0 V$ , $f = 1 MHz$                          | -    | 385   | -     |       |  |
| Reverse transfer capacitance                | C <sub>rss</sub>        |  | -    | 200   | -     |       |  |
| Total gate charge                           |                         | $V_{DS} = 4 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 7.2 \text{ A}$    | -    | 10.5  | 15.8  | nC    |  |
| Total gate charge                           | Qg                      |  | -    | 6     | 9     |       |  |
| Gate-source charge                          | Q <sub>gs</sub>         | $V_{DS} = 4 \text{ V}, V_{GS} = 2.5 \text{ V}, I_D = 7.2 \text{ A}$    | -    | 1.6   | -     |       |  |
| Gate-drain charge                           | $Q_{gd}$                |  | -    | 1     | -     |       |  |
| Gate resistance                             | $R_g$                   | f = 1 MHz  | 2.4  | 12    | 24    | Ω     |  |
| Turn-on delay time                          | t <sub>d(on)</sub>      |  | -    | 6     | 12    |       |  |
| Rise time                                   | t <sub>r</sub>          | $V_{DD} = 4 \text{ V}, R_{L} = 0.7 \Omega,$                            | -    | 14    | 20    | ns    |  |
| Turn-off delay time                         | t <sub>d(off)</sub>     | $I_D \cong 5.8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$     | -    | 65    | 98    |       |  |
| Fall time                                   | t <sub>f</sub>          |  | -    | 25    | 38    |       |  |
| <b>Drain-Source Body Diode Characterist</b> | cs                      |  |      |       |       |       |  |
| Continuous source-drain diode current       | I <sub>S</sub>          | T <sub>C</sub> = 25 °C   | -    | -     | 2.1   |       |  |
| Pulse diode forward current                 | I <sub>SM</sub>         |  | -    | -     | 30    | Α     |  |
| Body diode voltage                          | $V_{SD}$                | I <sub>S</sub> = 5.8 A, V <sub>GS</sub> = 0                            | -    | 0.82  | 1.2   | V     |  |
| Body diode reverse recovery time            | t <sub>rr</sub>         |  | -    | 40    | 60    | ns    |  |
| Body diode reverse recovery charge          | Q <sub>rr</sub>         | $I_F = 5.8 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$      | -    | 17    | 26    | nC    |  |
| Reverse recovery fall time                  | ta                      | T <sub>J</sub> = 25 °C   | -    | 15    | -     |       |  |
| Reverse recovery rise time                  | t <sub>b</sub>          |  | -    | 25    | -     | ns    |  |

#### Notes

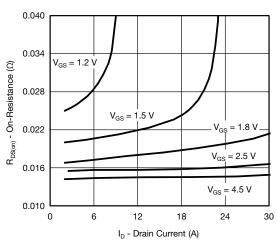
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

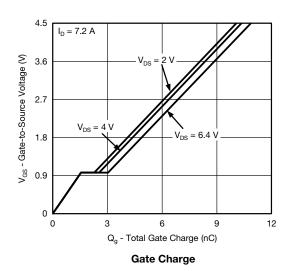


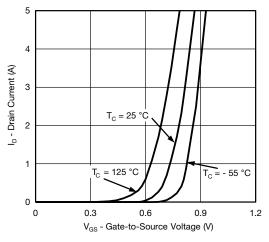


### **Output Characteristics**

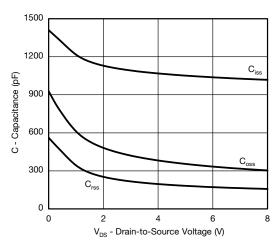


On-Resistance vs. Drain Current and Gate Voltage

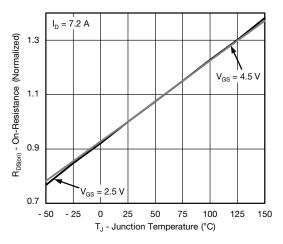




**Transfer Characteristics** 

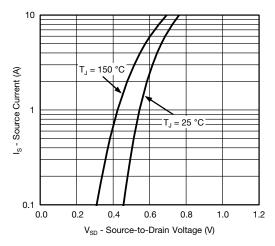


## Capacitance

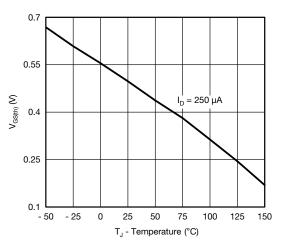


On-Resistance vs. Junction Temperature

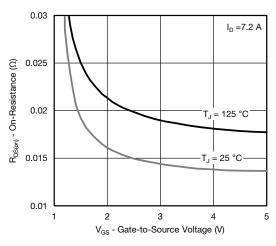




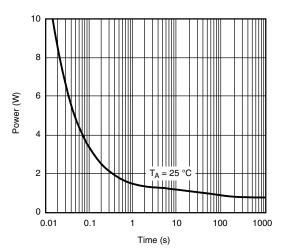
### Source-Drain Diode Forward Voltage



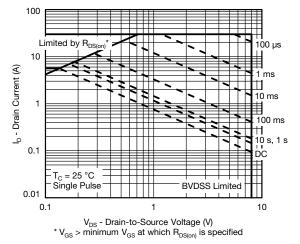
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

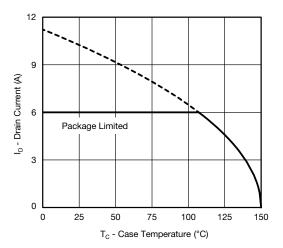


Single Pulse Power (Junction-to-Ambient)

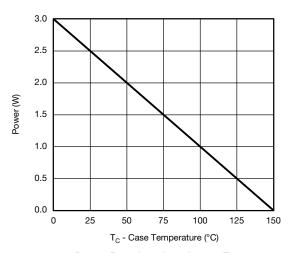


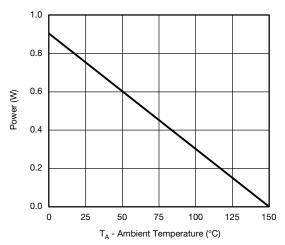
Safe Operating Area, Junction-to-Ambient





### Current Derating a





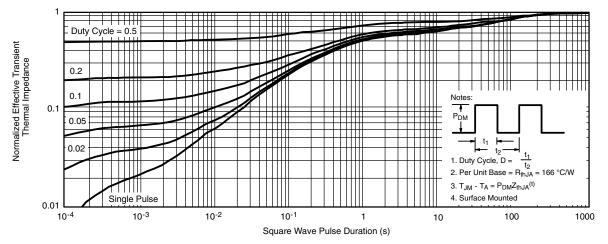
Power Derating, Junction-to-Foot

Power Derating, Junction-to-Ambient

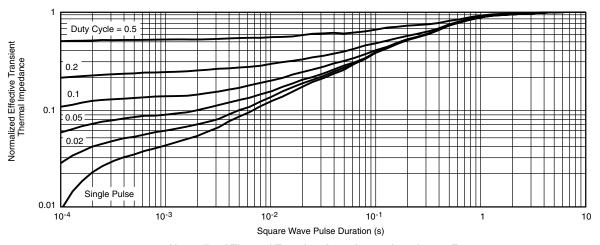
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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## SOT-23 (TO-236): 3-LEAD







| Dim —                    | MILLIN   | IETERS | INCHES     |       |  |
|--------------------------|----------|--------|------------|-------|--|
|                          | Min      | Max    | Min        | Max   |  |
| Α                        | 0.89     | 1.12   | 0.035      | 0.044 |  |
| A <sub>1</sub>           | 0.01     | 0.10   | 0.0004     | 0.004 |  |
| A <sub>2</sub>           | 0.88     | 1.02   | 0.0346     | 0.040 |  |
| b                        | 0.35     | 0.50   | 0.014      | 0.020 |  |
| С                        | 0.085    | 0.18   | 0.003      | 0.007 |  |
| D                        | 2.80     | 3.04   | 0.110      | 0.120 |  |
| E                        | 2.10     | 2.64   | 0.083      | 0.104 |  |
| E <sub>1</sub>           | 1.20     | 1.40   | 0.047      | 0.055 |  |
| е                        | 0.95 BSC |        | 0.0374 Ref |       |  |
| e <sub>1</sub>           | 1.90 BSC |        | 0.0748 Ref |       |  |
| L                        | 0.40     | 0.60   | 0.016      | 0.024 |  |
| L <sub>1</sub>           | 0.64 Ref |        | 0.025 Ref  |       |  |
| S                        | 0.50 Ref |        | 0.020 Ref  |       |  |
| q                        | 3°       | 8°     | 3°         | 8°    |  |
| ECN: S-03946-Rev. K. 09- | Jul-01   |        |            |       |  |

DWG: 5479

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## **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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